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(54) **Method of manufacturing an OLED display by using fiducial marks on a substrate for laser transfer of organic material from a donor to a substrate**

Verfahren zur Herstellung einer OLED-Anzeige auf einem Substrat unter Zuhilfenahme von Justiermarken zum Übertragen von organischem Material von einem Donor auf das Substrat mittels Lasertransfers

Procédé de fabrication d'un affichage DELO avec l'utilisation de marques d'alignement sur un substrat pour le transfert au laser de matériau organique à partir d'un donneur vers le substrat

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EP-A- 0 883 190 WO-A-00/14777
JP-A- H01 137 238 JP-A- 2002 082 334

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Description

[0001] The present invention relates to making organic light emitting devices (OLED) which transfers organic material from a donor to a substrate.

[0002] In color or full-color organic electroluminescent (EL) displays having an array of colored pixels such as red, green, and blue color pixels (commonly referred to as RGB pixels), precision patterning of the color-producing organic EL media is required to produce the RGB pixels. The basic EL device has in common an anode, a cathode, and an organic EL medium sandwiched between the anode and the cathode. The organic EL medium may consist of one or more layers of organic thin films, where one of the layers is primarily responsible for light generation or electroluminescence. This particular layer is generally referred to as the emissive layer of the organic EL medium. Other organic layers present in the organic EL medium may provide electronic transport functions primarily and are referred to as either the hole transport layer (for hole transport) or electron transport layer (for electron transport). In forming the RGB pixels in a full-color organic EL display panel, it is necessary to devise a method to precisely pattern the emissive layer of the organic EL medium or the entire organic EL medium.

[0003] Typically, electroluminescent pixels are formed on the display by shadow masking techniques, such as shown in US-A-5,742,129. Although this has been effective, it has several drawbacks. It has been difficult to achieve high resolution of pixel sizes using shadow masking. Moreover, it is challenging to align the substrate and the shadow mask, such that pixels are formed in the appropriate locations. When it is desirable to increase the substrate size, it is increasingly difficult to manipulate the shadow mask as part of the alignment process to form appropriately positioned pixels. A further disadvantage of the shadow mask method is that the mask holes can become plugged with time. Plugged holes on the mask lead to the undesirable result of nonfunctioning pixels on the EL display.

[0004] There are further problems with the shadow mask method, which become especially apparent when making EL devices with dimensions of more than a few inches on a side. It is extremely difficult to manufacture larger shadow masks with the required precision for accurately forming EL devices.

[0005] A method for patterning high-resolution organic EL displays has been disclosed in US-A-5,851,709 by Grande and others. This method is comprised of the following sequences of steps: 1) providing a substrate having opposing first and second surfaces; 2) forming a light-transmissive, heat-insulating layer over the first surface of the substrate; 3) forming a light-absorbing layer over the heat-insulating layer; 4) providing the substrate with an array of openings extending from the second surface to the heat-insulating layer; 5) providing a transferable, color-forming, organic donor layer formed on the light-absorbing layer; 6) precision aligning the donor substrate with the display substrate in an oriented relationship between the openings in the substrate and the corresponding color pixels on the device; and 7) employing a source of radiation for producing sufficient heat at the light-absorbing layer over the openings to cause the transfer of the organic layer on the donor substrate to the display substrate. A problem with the Grande and others approach is that patterning of an array of openings on the donor substrate is required. This creates many of the same problems as the shadow mask method, including the requirement for precision mechanical alignment between the donor substrate and the display substrate. A further problem is that the donor pattern is fixed and cannot be changed readily.

[0006] Using an unpatterned donor sheet and a precision light source, such as a laser, can remove some of the difficulties seen with a patterned donor. A series of patents by Wolk and others (US-A-6,114,088; US-A-6,140,009; US-A-6,214,520; US-A-6,221,553; EP 0 883 190A and WO 00/14777A) teach a method that can transfer the luminescent layer of an EL device from a donor sheet to a substrate by heating selected portions of the donor with laser light. Wolk and others comment that the use of light may be the preferred thermal transfer modality, in that it enables the precision registration needed in the manufacture of large scale devices. While laser thermal transfer does enable precision registration, it is essential that the beam of light be aligned and directed such that the correct regions of the substrate receive transferred donor material. Other means of thermal transfer would also depend upon means of precision alignment between the substrate and the thermal transfer means.

[0007] Document JP 2002-082334 A discloses a method for manufacturing of a liquid crystal device comprising aligning a substrate with high accuracy to obtain an accurate rubbing angle and to suppress fluctuations in the contrast.

[0008] Document JP 1-137238 A discloses a method for manufacturing an active matrix array which prevents erroneous recognition by allowing the shape of a picture element of a prescribed part to be different from the shape of a picture element of the periphery so that a reflection factor of a laser beam against a scanning position is made different, when an alignment is executed.

[0009] It is an object of the present invention to provide a more effective way of aligning a substrate with a laser beam, which is independent of thermal expansion of the substrate.

[0010] It is another object of the present invention to minimize the number of alignment steps needed to properly align the laser and the substrate.

[0011] These objects are achieved by a method of manufacturing an OLED display with the steps of claim 1.

[0012] It is an advantage of the present invention that, by providing fiducial mark(s) on a substrate, an effective way of determining the position and orientation of the substrate can be accomplished prior to transfer of the organic materials.

It is a further advantage of the present invention that the same laser beam which is used for transfer from a donor element to the substrate can also be used to determine the position and orientation of the substrate relative to the laser. Alignment in accordance with the present invention is highly accurate and is provided by a direct detection of the fiducial marks. A further advantage of the present invention is that highly accurate alignment information can be developed with a minimum number of steps. Another advantage of the present invention is that it permits the automatic alignment of the laser beam to transfer material to different pixel sites.

FIG. 1a is a top view of an OLED substrate constructed in accordance with the present invention;

FIG. 1b is a cross-sectional representation of the positioning of a substrate relative to a laser;

FIG. 2 is an expanded top view of a portion of the above substrate showing fiducial marks and the position of a photodetector and laser spot;

FIG. 3 shows one embodiment of an apparatus providing relative movement that enables the method described herein;

FIG. 4a shows a cross-sectional view of a laser irradiating a secured substrate/donor element combination with a beam of light in accordance with this invention;

FIG. 4b shows a cross-sectional view of an OLED substrate and a donor element properly positioned relative to the substrate in the practice of this invention;

FIG. 5 shows a block diagram of the electrooptical subsystems which are used to process signals and detect and determine the positions of the fiducial marks; and

FIG. 6 is a block diagram showing the overall steps in detecting the positions of the fiducial marks.

[0013] The term "display" or "display panel" is employed to designate a screen capable of electronically displaying video images or text. The term "pixel" is employed in its art-recognized usage to designate an area of a display panel that can be stimulated to emit light independently of other areas. The term "OLED device" or "OLED display" is used in its art-recognized meaning of a display device comprising organic light-emitting diodes as pixels. A color OLED device emits light of at least one color. The term "multicolor" is employed to describe a display panel that is capable of emitting light of a different hue in different areas. In particular, it is employed to describe a display panel that is capable of displaying images of different colors. These areas are not necessarily contiguous. The term "full color" is employed to describe multicolor display panels that are capable of emitting in the red, green, and blue regions of the visible spectrum and displaying images in any hue or combination of hues. The red, green, and blue colors constitute the three primary colors from which all other colors can be generated by appropriately mixing these three primaries. The term "hue" refers to the intensity profile of light emission within the visible spectrum, with different hues exhibiting visually discernible differences in color. The pixel or subpixel is generally used to designate the smallest addressable unit in a display panel. For a monochrome display, there is no distinction between pixel or subpixel. The term "subpixel" is used in multicolor display panels and is employed to designate any portion of a pixel which can be independently addressable to emit a specific color. For example, a blue subpixel is that portion of a pixel which can be addressed to emit blue light. In a full-color display, a pixel generally comprises three primary-color subpixels, namely blue, green, and red. The term "pitch" is used to designate the distance separating two pixels or subpixels in a display panel. Thus, a subpixel pitch means the separation between two subpixels.

[0014] Turning now to FIG. 1a, there is shown a top view of an OLED substrate **10** constructed in accordance with this invention. OLED substrate **10** includes an array of pixel portions **12**. Such pixel portions **12** are each associated with electrodes and can be part of a so-called passive display which has overlapping rows and columns of electrodes, or part of an active display which has a common anode and individual thin-film transistors (TFTs). Each pixel portion **12** can be a pixel (for monochrome displays) or sub-pixel (for full-color displays). The distance between individual pixels or sub-pixels can be desired to be less than 100 micrometers in such devices.

[0015] Substrate **10** can be an organic solid, an inorganic solid, or a combination of organic and inorganic solids that provides a surface for receiving the emissive material from a donor. Substrate **10** can be rigid or flexible and can be processed as separate individual pieces, such as sheets or wafers, or as a continuous roll. Typical substrate materials include glass, plastic, metal, ceramic, semiconductor, metal oxide, semiconductor oxide, semiconductor nitride, or combinations thereof. Substrate **10** can be a homogeneous mixture of materials, a composite of materials, or multiple layers of materials. Substrate **10** can be an OLED substrate, that is a substrate commonly used for preparing OLED displays, for example, active-matrix low-temperature polysilicon TFT substrate. The substrate **10** can either be light transmissive or opaque, depending on the intended direction of light emission and fiducial detection. The light transmissive property is desirable for viewing the EL emission through the substrate and for viewing a laser spot through the substrate. Transparent glass or plastic are commonly employed in such cases. For applications where the EL emission is viewed through the top electrode, the transmissive characteristic of the bottom support is immaterial, and therefore can be light transmissive, light absorbing or light reflective. Substrates for use in this case include, but are not limited to, glass, plastic, semiconductor materials, ceramics, and circuit board materials. For the purpose of this invention, substrate **10**

is preferably an OLED substrate and the terms "substrate" and "OLED substrate" will be used interchangeably.

[0016] FIG. 1a additionally shows fiducial marks **40** and **42** on substrate **10**. Fiducial marks are features on substrate **10** which are detectable by a means, for example, optically, and are usable for determining the position and orientation of substrate **10** for properly depositing the emissive layer relative to pixel portions **12** in a manner which will be evident. These features, which are the fiducial marks, may have other purposes, such as being part of an active or passive matrix. One or more fiducial marks are formed in known positions of substrate **10**. Fiducial marks **40** and **42** are preferably outside material transfer area **14**, which is the area where the organic material is to be transferred onto substrate **10** to form one or more OLED displays. Fiducial marks **40** and **42** are designed to enable the identification of a specific point on substrate **10** and can have a specified shape, which can include intersecting crosshairs, a triangle, a cross, a circle, a square, intersecting triangles, an "X", or any other shape that can be utilized to define a point. A fiducial mark should not be infinitely rotationally symmetric (for example, a circle or a bulls-eye) unless a second fiducial mark is to be used. A single fiducial mark can be partially rotationally symmetric, such that the extent of rotational symmetry would cause substantial substrate misalignment that is obvious even to the naked eye (for example, a cross, which is rotationally symmetric at 90° intervals). In a preferred embodiment the fiducial mark **40** is a cross, although it is realized that any non- or limited-rotationally symmetric mark can allow the rotational position to be determined. For greater accuracy, a preferred embodiment is to provide two fiducial marks **40** and **42**, each such mark having a specified shape such as a cross, on substrate **10** and separated by a distance of at least 50% of the length of substrate **10**. Each fiducial mark is located above a light detector.

[0017] FIG. 1b shows a cross-sectional representation of the positioning of a substrate **10** relative to a laser **100**, which produces laser beam **74**. In this embodiment, substrate **10** is positioned between laser **100** and light detector **22** so that by providing relative movement between substrate **10** and laser **100** and laser beam **74**, laser beam **74** can impinge upon fiducial mark **42**. Light detector **22** can detect when laser beam **74** impinges upon fiducial mark **42**.

[0018] FIG. 2 shows an expanded top view of a portion of substrate **10** showing fiducial mark **40** and the position of light detector **22** and laser spot **20**. Light detector **22** can be for example, a photodetector. Light detector **22** includes light detector active area **24**, which is the part of light detector **22** that is sensitive to impinging light, such as that provided by laser spot **20**. In this particular embodiment, light detector **22** is located below substrate **10** and substrate **10** is sufficiently transparent such that sufficient light passes through substrate **10** to be detected by light detector **22**. By providing relative movement between the substrate **10** and the laser **100** and the laser beam **74**, the position and orientation of fiducial mark **40** can be detected. By relative movement is meant movement of one or more parts of this apparatus such that the positions of laser spot **20**, substrate **10**, and light detector **22** are changed relative to one another. This can be achieved by a variety of methods, such as moving laser spot **20**, moving substrate **10**, moving both laser spot **20** and light detector **22**, and so forth. Providing relative movement in a raster scanning method, that is a two-dimensional sequence of scan lines, allows one to build an image of fiducial mark **40**. In the preferred embodiment wherein the fiducial mark is a cross, the angular rotation of fiducial mark can be deduced from the angle between the scan line and the horizontal line of the plus sign.

[0019] In a preferred embodiment employing two fiducial marks **40** and **42**, the angle of rotational misalignment can be determined more accurately than with a single fiducial mark by virtue of the increased distance between the two fiducial marks. This is accomplished by measuring the center of both fiducial marks **40** and **42** and calculating the angle formed the laser spot scan **48** and the line between the fiducial marks. This angle can then be compared to the desired orientation and appropriate adjustments made. Knowing the center of the fiducials also allows one to obtain the relative x, y displacement relative to a desired location and appropriate translation of the substrate or, alternatively, modification of the image file such that image placement is now rotationally and translationally correct.

[0020] Other embodiments are also possible. For example, both light detector **22** and laser spot **20** can be on the same side, that is, above substrate **10**. In this case, substrate **10** need not be transparent, and light detector **22** detects reflected light from the surface of substrate **10**.

[0021] FIG. 2 additionally shows the relative strength of light detector signal intensity **50** in relation to relative light detector position **46**. Relative movement causes the apparent position of laser spot **20** to change so that laser beam **74** impinges upon fiducial mark **40** in multiple locations, as shown by laser spot scan **48**. Light detector signal intensity **50**, as measured by signal strength **44**, is strong in the region of light detector active area **24**, unless diminished by fiducial mark **40**. Light detector **22** can detect when laser beam **74** impinges upon fiducial mark **40** by the change in light detector signal intensity **50**. Information, such as light detector signal intensity **50** with respect to relative light detector position **46**, can be recorded or computed from the detection of fiducial marks such as **40**. Thus, it is possible to determine the position of fiducial center **26** in the first direction. By techniques such as additional laser spot scans, it is possible to determine the position of the center of fiducial mark **40** in a second perpendicular direction. Recorded information can be used to calculate the orientation and position of substrate **10**.

[0022] Turning now to FIG. 3 there is shown one embodiment of an apparatus **18** providing relative movement between substrate **10** and the laser **100** and the laser beam **74** that enables the method described herein. The apparatus **18** includes apparatus to move substrate **10**, that is, y-axis translation stage **30**, x-axis translation stage **32**, and rotation

stage **34** with hold-down platen **36**. Hold-down platen **36** includes light detectors **22**, which are not shown for clarity. Laser **100**, which is not shown, is located in a fixed position above hold-down platen **36** and substrate **10**.

[0023] Substrate **10** is transversely and angularly movable to selected positions to provide relative movement between laser spot **20** and substrate **10** in a manner which will now be described. Substrate **10** is mounted on hold-down platen **36** which can be, for example, a vacuum hold-down apparatus. Laser spot **20** can be from, for example, a laser printhead. X-axis translation stage **32** is capable of moving and locating substrate **10** in a transverse direction with a resolution on the order of micrometers. X-axis translation stage **32** is commercially available from manufacturers such as Dover Instruments Corp. X-axis translation stage **32** can adjust for lateral displacement in one direction, thus making substrate **10** transversely movable to adjust the position of laser spot **20** in relation to substrate **10**.

[0024] X-axis translation stage **32** is mounted to y-axis translation stage **30**. The latter is similar to, but arranged in a manner orthogonal to x-axis translation stage **32**, and is thus capable of moving x-axis translation stage **32**, and by extension substrate **10**, in a perpendicular direction, with a resolution on the order of micrometers.

[0025] Mounted to x-axis translation stage **32** is rotation stage **34**. Rotation stage **34** allows angular adjustment of hold-down platen **36** and substrate **10**, thus angularly moving substrate **10**.

[0026] FIG. 4a shows a cross-sectional view of laser **100** irradiating a secured substrate/donor element combination with a beam of light in accordance with this invention. Laser **100** can be a multichannel laser which emits a modulated multichannel linear laser light beam. The translation stages are not shown for clarity. Donor element **16** is positioned between laser **100** and substrate **10** in a transfer relationship with substrate **10**, that is, donor element **16** is placed in contact with substrate **10** (not shown), or is held with a controlled separation from substrate **10**. Donor element **16** is held in position by pressurizing means **96**. Pressurizing means **96** can be a transparent support or can be a chamber that is pressurized with gas to secure donor element **16** in a close relationship with substrate **10**.

[0027] Laser **100** emits laser beam **74** which can be multichannel, that is to say multiple modulated channels of a linear laser light beam, through print lens **94**. Laser beam **74** is drawn for clarity of illustration as a series of lines to emphasize that it can be multichannel in nature as a plurality of individually addressable channels of laser light. It will be understood that these channels can be contiguous and behave on irradiation as a continuous band of laser light. Laser beam **74** can be directed onto donor element **16** through pressurizing means **96**, which is transparent, and strikes the non-transfer surface of donor element **16**. A desired pattern can be obtained by modulating laser beam **74** while providing relative motion between laser **100** and substrate **10**.

[0028] Turning now to FIG. 4b, there is shown a cross-sectional view showing an OLED substrate and a donor element properly positioned relative to the substrate in the practice of this invention. Donor element **16** and substrate **10** are in a transfer relationship, that is, donor element **16** is placed on or close to substrate **10**. Donor element **16** includes support **68**, energy-absorbing layer **70**, and a layer of organic material **72**. Donor element **16** is unpatterned, that is, energy-absorbing layer **70** and organic material **72** are coated evenly on the surface of support **68**. Organic material **72** is transferred from transfer surface **78** of donor element **16** to substrate **10** by selective irradiation of non-transfer surface **76** of donor element **16** by laser beam **74**, which is absorbed by and heats selected portions of energy-absorbing material **70** and thereby heats selected portions of organic material **72**. Selective irradiation is accomplished by providing relative movement between laser beam **74** and substrate **10**, and activating laser beam **74** in accordance with the determined position and orientation of substrate **10** to cause the transfer of organic material **72** from donor element **16** onto substrate **10** at the desired positions, for example, pixel portions **12**. Laser beam **74** can be activated according to timing or according to position. The selected portions of organic material **72** are vaporized or sublimed to become organic layer **82** upon transfer to substrate **10**.

[0029] Energy-absorbing layer **70** does not permit laser beam **74** to pass through to substrate **10**. In one embodiment, aligning substrate **10** can be done before placing donor element **16** onto substrate **10**. In another embodiment, donor element **16** does not include energy-absorbing layer **70** in the region of fiducial marks **40** and **42** and therefore is sufficiently transparent in the region of fiducial marks **40** and **42** so that donor element **16** permits sufficient light to pass therethrough to impinge upon fiducial marks **40** and **42** to enable the method herein. In this case, donor element **16** can be placed on substrate **10** before performing the aligning process.

[0030] The support **68** can be made of any of several materials which meet at least the following requirements. The donor support must be sufficiently flexible and possess adequate tensile strength to tolerate precoating steps and roll-to-roll or stacked-sheet transport of the support in the practice of the invention. Support **68** must be capable of maintaining the structural integrity during the light-to-heat-induced transfer step while pressurized on one side, and during any preheating steps contemplated to remove volatile constituents such as water vapor. Additionally, support **68** must be capable of receiving on one surface a relatively thin coating of organic material, and of retaining this coating without degradation during anticipated storage periods of the coated support. Support materials meeting these requirements include, for example, metal foils, certain plastic foils which exhibit a glass transition temperature value higher than a support temperature value anticipated to cause transfer of the transferable organic materials of the coating on the support, and fiber-reinforced plastic foils. While selection of suitable support materials can rely on known engineering approaches, it will be appreciated that certain aspects of a selected support material merit further consideration when configured as

a donor support useful in the practice of the invention. For example, the support material can require a multi-step cleaning and surface preparation process prior to precoating with transferable organic material. If the support material is a radiation-transmissive material, the incorporation into the support or onto a surface thereof, of a radiation-absorptive material can be advantageous to more effectively heat the donor support and to provide a correspondingly enhanced transfer of transferable organic donor material from the support to the substrate, when using a flash of radiation from a suitable flash lamp or laser light from a suitable laser.

[0031] Energy-absorbing layer **70** is capable of absorbing radiation in a predetermined portion of the spectrum and producing heat. Energy-absorbing layer can be a dye such as the dyes specified in commonly assigned US-A-5,578,416, a pigment such as carbon, or a metal such as nickel, chromium, titanium, and so forth.

[0032] A typical OLED device can contain the following layers, usually in this sequence: an anode, a hole-injecting layer, a hole-transporting layer, a light-emitting layer, an electron-transporting layer, a cathode. Any or all of these can comprise organic material **72**, thus forming an organic layer. Organic material **72** can be a hole-injecting material, a hole-transport material, an electron-transport material, an emissive material, a host material, or a combination of any of these materials.

Hole-Injecting (HI) Material

[0033] While not always necessary, it is often useful that a hole-injecting layer be provided in an organic light-emitting display. The hole-injecting material can serve to improve the film formation property of subsequent organic layers and to facilitate injection of holes into the hole-transporting layer. Suitable materials for use in the hole-injecting layer include, but are not limited to, porphyrinic compounds as described in US-A-4,720,432, and plasma-deposited fluorocarbon polymers as described in US-A-6,208,075. Alternative hole-injecting materials reportedly useful in organic EL devices are described in EP 0 891 121 A1 and EP 1,029,909 A1.

Hole-Transport (HT) Material

[0034] Hole-transport materials useful as organic material **72** are well known to include compounds such as an aromatic tertiary amine, where the latter is understood to be a compound containing at least one trivalent nitrogen atom that is bonded only to carbon atoms, at least one of which is a member of an aromatic ring. In one form the aromatic tertiary amine can be an arylamine, such as a monoarylamine, diarylamine, triarylamine, or a polymeric arylamine. Exemplary monomeric triarylaminines are illustrated by Klupfel and others in US-A-3,180,730. Other suitable triarylaminines substituted with one or more vinyl radicals and/or comprising at least one active hydrogen containing group are disclosed by Brantley and others in US-A-3,567,450 and US-A-3,658,520.

[0035] A more preferred class of aromatic tertiary amines are those which include at least two aromatic tertiary amine moieties as described in US-A-4,720,432 and US-A-5,061,569. Such compounds include those represented by structural Formula (A).



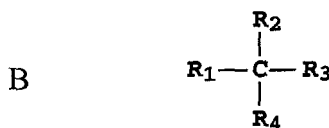
wherein:

Q_1 and Q_2 are independently selected aromatic tertiary amine moieties; and

G is a linking group such as an arylene, cycloalkylene, or alkylene group of a carbon to carbon bond.

In one embodiment, at least one of Q_1 or Q_2 contains a polycyclic fused ring structure, for example, a naphthalene. When G is an aryl group, it is conveniently a phenylene, biphenylene, or naphthalene moiety.

[0036] A useful class of triarylaminines satisfying structural Formula (A) and containing two triarylamine moieties is represented by structural Formula (B).



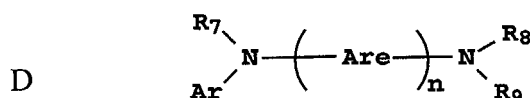
where:

R_1 and R_2 each independently represents a hydrogen atom, an aryl group, or an alkyl group or R_1 and R_2 together represent the atoms completing a cycloalkyl group; and
 R_3 and R_4 each independently represents an aryl group, which is in turn substituted with a diaryl substituted amino group, as indicated by structural Formula (C).



wherein R_5 and R_6 are independently selected aryl groups. In one embodiment, at least one of R_5 or R_6 contains a polycyclic fused ring structure, for example, a naphthalene.

[0037] Another class of aromatic tertiary amines are the tetraaryldiamines. Desirable tetraaryldiamines include two diarylamino groups, such as indicated by Formula (C), linked through an arylene group. Useful tetraaryldiamines include those represented by Formula (D).



wherein:

each Are is an independently selected arylene group, such as a phenylene or anthracene moiety;

n is an integer of from 1 to 4; and

Ar, R_7 , R_8 , and R_9 are independently selected aryl groups.

[0038] In a typical embodiment, at least one of Ar, R_7 , R_8 , and R_9 is a polycyclic fused ring structure, for example, a naphthalene.

[0039] The various alkyl, alkylene, aryl, and arylene moieties of the foregoing structural Formulae (A), (B), (C), (D), can each in turn be substituted. Typical substituents include alkyl groups, alkoxy groups, aryl groups, aryloxy groups, and halogen such as fluoride, chloride, and bromide. The various alkyl and alkylene moieties typically contain from about 1 to 6 carbon atoms. The cycloalkyl moieties can contain from 3 to about 10 carbon atoms, but typically contain five, six, or seven ring carbon atoms—for example, cyclopentyl, cyclohexyl, and cycloheptyl ring structures. The aryl and arylene moieties are usually phenyl and phenylene moieties.

[0040] The hole-transporting layer can be formed of a single or a mixture of aromatic tertiary amine compounds. Specifically, one can employ a triarylamine, such as a triarylamine satisfying the Formula (B), in combination with a tetraaryldiamine, such as indicated by Formula (D). When a triarylamine is employed in combination with a tetraaryldiamine, the latter is positioned as a layer interposed between the triarylamine and the electron injecting and transporting layer. Illustrative of useful aromatic tertiary amines are the following:

1,1-Bis(4-di-*p*-tolylaminophenyl)cyclohexane
 1,1-Bis(4-di-*p*-tolylaminophenyl)-4-phenylcyclohexane
 4,4'-Bis(diphenylamino)quadriphenyl
 Bis(4-dimethylamino-2-methylphenyl)-phenylmethane
 N,N,N-Tri(*p*-tolyl)amine
 4-(di-*p*-tolylamino)-4'-[4(di-*p*-tolylamino)-styryl]stilbene
 N,N,N',N'-Tetra-*p*-tolyl-4,4'-diaminobiphenyl
 N,N,N',N'-Tetraphenyl-4,4'-diaminobiphenyl
 N-Phenylcarbazole
 Poly(N-vinylcarbazole)
 N,N'-di-1-naphthalenyl-N,N'-diphenyl-4,4'-diaminobiphenyl
 4,4'-Bis[N-(1-naphthyl)-N-phenylamino]biphenyl
 4,4"-Bis[N-(1-naphthyl)-N-phenylamino]*p*-terphenyl
 4,4'-Bis[N-(2-naphthyl)-N-phenylamino]biphenyl
 4,4'-Bis[N-(3-acenaphthenyl)-N-phenylamino]biphenyl
 1,5-Bis[N-(1-naphthyl)-N-phenylamino]naphthalene
 4,4'-Bis[N-(9-anthryl)-N-phenylamino]biphenyl

4,4"-Bis[N-(1-anthryl)-N-phenylamino]-*p*-terphenyl
 4,4'-Bis[N-(2-phenanthryl)-N-phenylamino]biphenyl
 4,4'-Bis[N-(8-fluoranthryl)-N-phenylamino]biphenyl
 4,4'-Bis[N-(2-pyrenyl)-N-phenylamino]biphenyl
 4,4'-Bis[N-(2-naphthacenyl)-N-phenylamino]biphenyl
 4,4'-Bis[N-(2-perylenyl)-N-phenylamino]biphenyl
 4,4'-Bis[N-(1-coroneryl)-N-phenylamino]biphenyl
 2,6-Bis(di-*p*-tolylamino)naphthalene
 2,6-Bis[di-(1-naphthyl)amino]naphthalene
 2,6-Bis[N-(1-naphthyl)-N-(2-naphthyl)amino]naphthalene
 N,N,N',N'-Tetra(2-naphthyl)-4,4"-diamino-*p*-terphenyl
 4,4'-Bis[N-phenyl-N-[4-(1-naphthyl)-phenyl]amino]biphenyl
 4,4'-Bis[N-phenyl-N-(2-pyrenyl)amino]biphenyl
 2,6-Bis[N,N-di(2-naphthyl)amine]fluorene
 1,5-Bis[N-(1-naphthyl)-N-phenylamino]naphthalene

[0041] Another class of useful hole-transport materials includes polycyclic aromatic compounds as described in EP 1 009 041. In addition, polymeric hole-transporting materials can be used such as poly(N-vinylcarbazole) (PVK), polythiophenes, polypyrrole, polyaniline, and copolymers such as poly(3,4-ethylenedioxythiophene)/poly(4-styrenesulfonate) also called PEDOT/PSS.

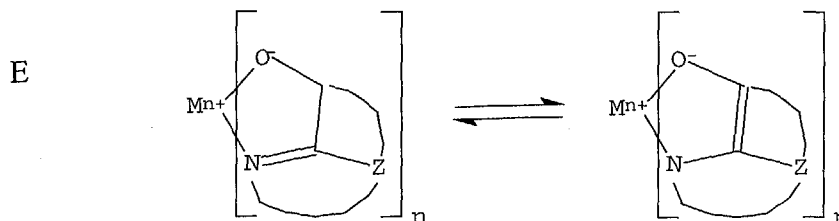
Light-Emitting Material

[0042] Light-emitting materials useful as organic material 72 are well known. As more fully described in US-A-4,769,292 and US-A-5,935,721, the light-emitting layer (LEL) of the organic EL element comprises a luminescent or fluorescent material where electroluminescence is produced as a result of electron-hole pair recombination in this region. The light-emitting layer can be comprised of a single material, but more commonly consists of a host material doped with a guest compound or compounds where light emission comes primarily from the dopant and can be of any color. The host materials in the light-emitting layer can be an electron-transporting material, as defined below, a hole-transporting material, as defined above, or another material that supports hole-electron recombination. The dopant is usually chosen from highly fluorescent dyes, but phosphorescent compounds, for example, transition metal complexes as described in WO 98/55561, WO 00/18851, WO 00/57676, and WO 00/70655 are also useful. Dopants are typically coated as 0.01 to 10 % by weight into the host material.

[0043] An important relationship for choosing a dye as a dopant is a comparison of the bandgap potential which is defined as the energy difference between the highest occupied molecular orbital and the lowest unoccupied molecular orbital of the molecule. For efficient energy transfer from the host to the dopant molecule, a necessary condition is that the band gap of the dopant is smaller than that of the host material.

[0044] Host and emitting molecules known to be of use include, but are not limited to, those disclosed in US-A-4,768,292; US-A-5,141,671; US-A-5,150,006; US-A-5,151,629; US-A-5,294,870; US-A-5,405,709; US-A-5,484,922; US-A-5,593,788; US-A-5,645,948; US-A-5,683,823; US-A-5,755,999; US-A-5,928,802; US-A-5,935,720; US-A-5,935,721; and US-A-6,020,078.

[0045] Metal complexes of 8-hydroxyquinoline and similar derivatives (Formula E) constitute one class of useful host compounds capable of supporting electroluminescence, and are particularly suitable for light emission of wavelengths longer than 500 nm, for example, green, yellow, orange, and red.



wherein:

M represents a metal;
 n is an integer of from 1 to 3; and

Z independently in each occurrence represents the atoms completing a nucleus having at least two fused aromatic rings.

[0046] From the foregoing it is apparent that the metal can be monovalent, divalent, or trivalent metal. The metal can, for example, be an alkali metal, such as lithium, sodium, or potassium; an alkaline earth metal, such as magnesium or calcium; or an earth metal, such as boron or aluminum. Generally any monovalent, divalent, or trivalent metal known to be a useful chelating metal can be employed.

[0047] Z completes a heterocyclic nucleus containing at least two fused aromatic rings, at least one of which is an azole or azine ring. Additional rings, including both aliphatic and aromatic rings, can be fused with the two required rings, if required. To avoid adding molecular bulk without improving on function the number of ring atoms is usually maintained at 18 or less.

[0048] Illustrative of useful chelated oxinoid compounds are the following:

CO-1: Aluminum trisoxine [alias, tris(8-quinolinolato)aluminum(III)]

CO-2: Magnesium bisoxine [alias, bis(8-quinolinolato)magnesium(II)]

CO-3: Bis[benzo(f)-8-quinolinolato]zinc (II)

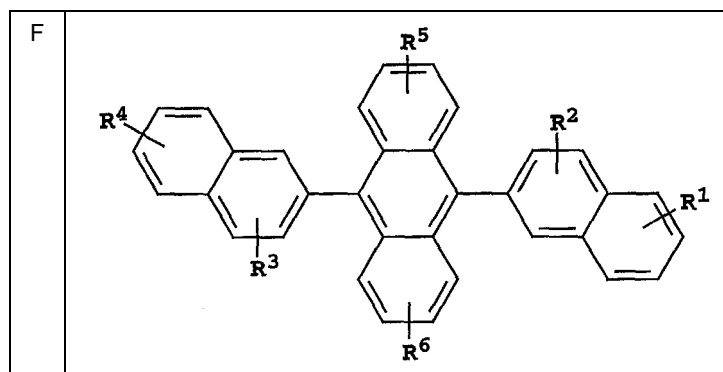
CO-4: Bis(2-methyl-8-quinolinolato)aluminum(III)- μ -oxo-bis(2-methyl-8-quinolinolato) aluminum(III)

CO-5: Indium trisoxine [alias, tris(8-quinolinolato)indium]

CO-6: Aluminum tris(5-methyloxine) [alias, tris(5-methyl-8-quinolinolato) aluminum(III)]

CO-7: Lithium oxine [alias, (8-quinolinolato)lithium(I)]

[0049] Derivatives of 9,10-di-(2-naphthyl)anthracene (Formula F) constitute one class of useful hosts capable of supporting electroluminescence, and are particularly suitable for light emission of wavelengths longer than 400 nm, for example, blue, green, yellow, orange, or red.



wherein R¹, R², R³, R⁴, R⁵, and R⁶ represent one or more substituents on each ring where each substituent is individually selected from the following groups:

Group 1: hydrogen, or alkyl of from 1 to 24 carbon atoms;

Group 2: aryl or substituted aryl of from 5 to 20 carbon atoms;

Group 3: carbon atoms from 4 to 24 necessary to complete a fused aromatic ring of anthracenyl; pyrenyl, or perylenyl;

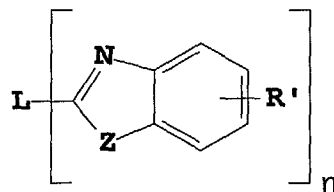
Group 4: heteroaryl or substituted heteroaryl of from 5 to 24 carbon atoms as necessary to complete a fused hetero-aromatic ring of furyl, thienyl, pyridyl, quinolinyl or other heterocyclic systems;

Group 5: alkoxyamino, alkylamino, or arylamino of from 1 to 24 carbon atoms; and

Group 6: fluorine, chlorine, bromine or cyano.

Benzazole derivatives (Formula G) constitute another class of useful hosts capable of supporting electroluminescence, and are particularly suitable for light emission of wavelengths longer than 400 nm, for example, blue, green, yellow, orange, or red.

G



where:

n is an integer of 3 to 8;

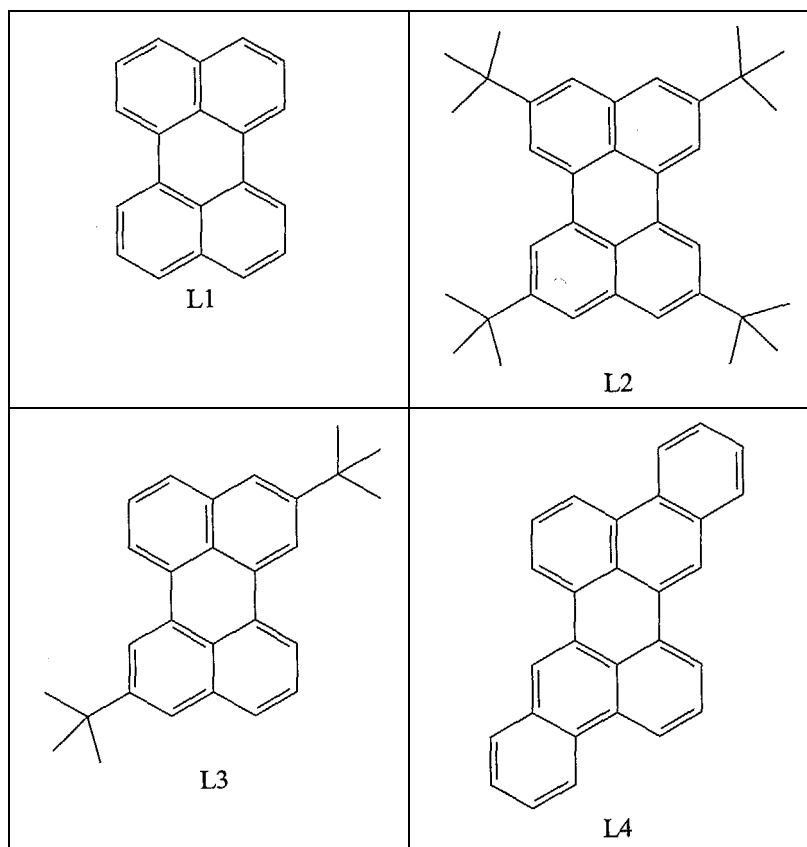
Z is O, NR or S;

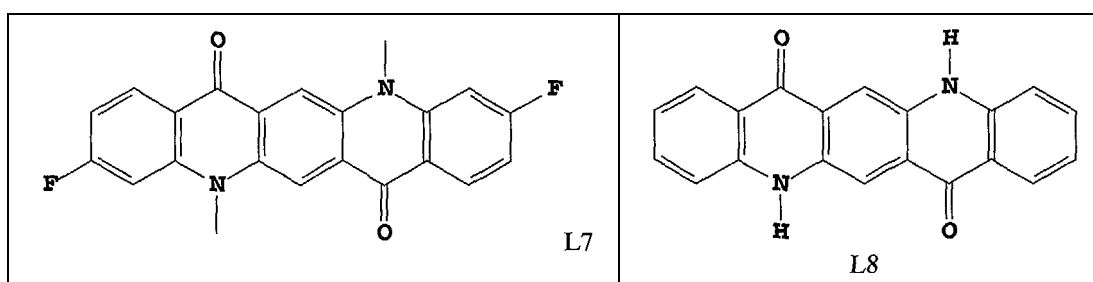
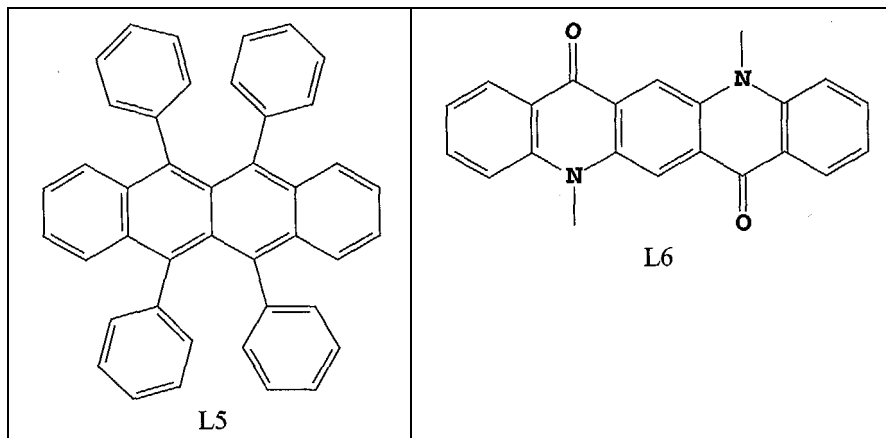
R' is hydrogen; alkyl of from 1 to 24 carbon atoms, for example, propyl, t-butyl, heptyl, and the like; aryl or heteroatom substituted aryl of from 5 to 20 carbon atoms for example phenyl and naphthyl, furyl, thienyl, pyridyl, quinolinyl and other heterocyclic systems; or halo such as chloro, fluoro; or atoms necessary to complete a fused aromatic ring; and

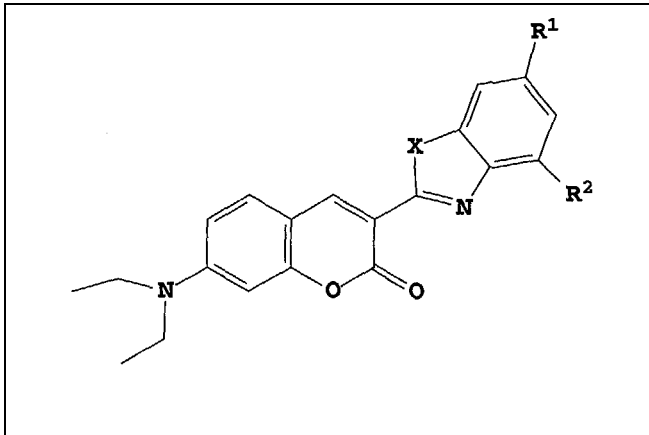
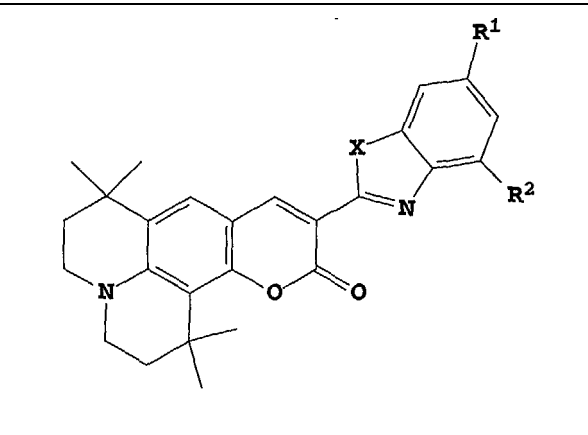
L is a linkage unit consisting of alkyl, aryl, substituted alkyl, or substituted aryl, which conjugately or unconjugately connects the multiple benzazoles together.

[0050] An example of a useful benzazole is 2,2',2''-(1,3,5-phenylene)tris[1-phenyl-1H-benzimidazole].

[0051] Desirable fluorescent dopants include derivatives of anthracene, tetracene, xanthene, perylene, rubrene, coumarin, rhodamine, quinacridone, dicyanomethylenepyran compounds, thiopyran compounds, polymethine compounds, pyrilium and thiapyrilium compounds, and carbostyryl compounds. Illustrative examples of useful dopants include, but are not limited to, the following:

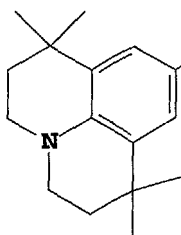
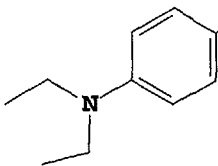


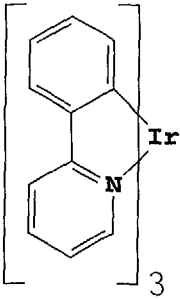
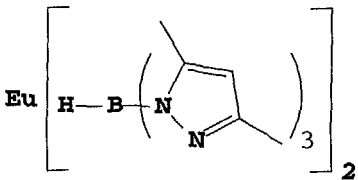


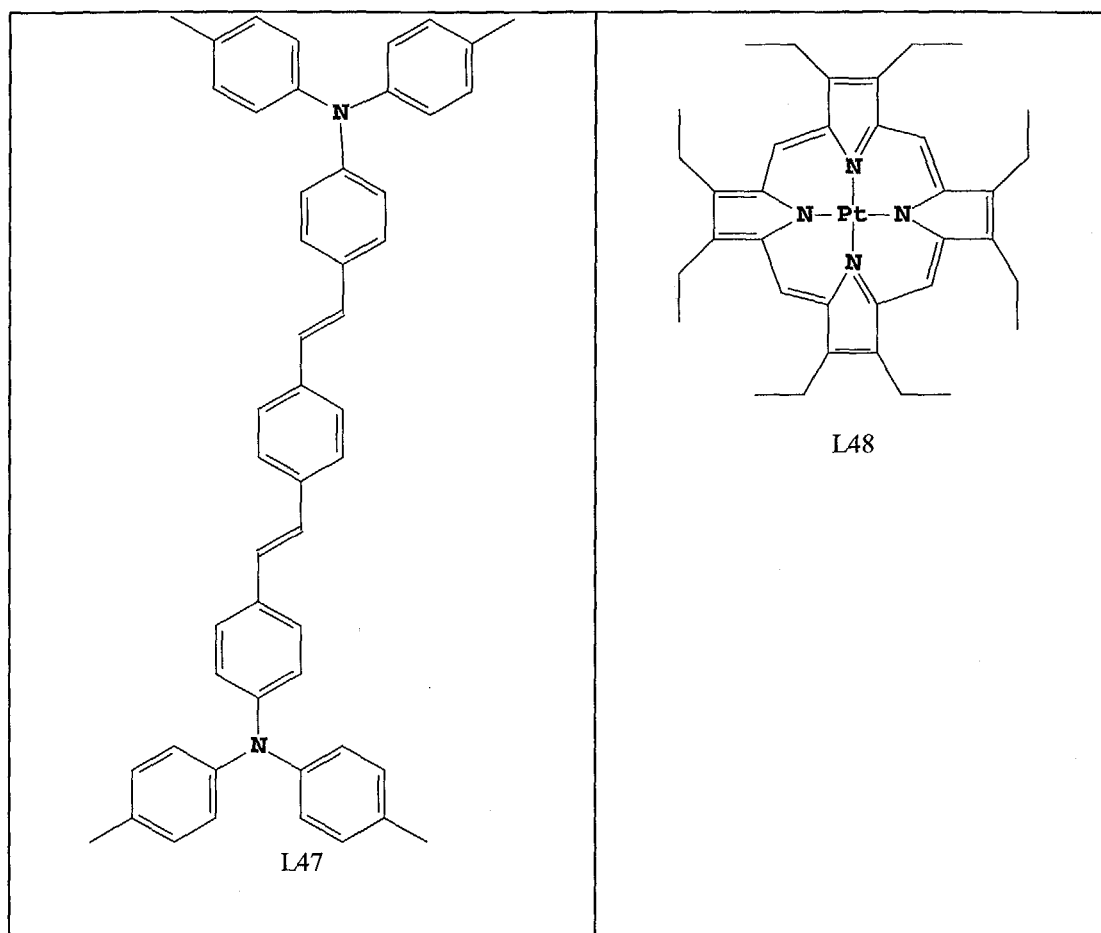
									
	X	R1	R2			X	R1	R2	
L9	O	H	H		L23	O	H	H	
L10	O	H	Methyl		L24	O	H	Methyl	
L11	O	Methyl	H		L25	O	Methyl	H	
L12	O	Methyl	Methyl		L26	O	Methyl	Methyl	
L13	O	H	t-butyl		L27	O	H	t-butyl	
L14	O	t-butyl	H		L28	O	t-butyl	H	
L15	O	t-butyl	t-butyl		L29	O	t-butyl	t-butyl	
L16	S	H	H		L30	S	H	H	
L17	S	H	Methyl		L31	S	H	Methyl	
L18	S	Methyl	H		L32	S	Methyl	H	
L19	S	Methyl	Methyl		L33	S	Methyl	Methyl	
L20	S	H	t-butyl		L34	S	H	t-butyl	
L21	S	t-butyl	H		L35	S	t-butyl	H	

(continued)

	<u>X</u>	<u>R1</u>	<u>R2</u>		<u>X</u>	<u>R1</u>	<u>R2</u>
L22	S	t-butyl	t-butyl	L36	S	t-butyl	t-butyl

			
L37	<u>R</u> phenyl	L41	<u>R</u> phenyl
L38	methyl	L42	methyl
L39	t-butyl	L43	t-butyl
L40	mesityl	L44	mesityl

 L45	 L46
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[0052] Other organic emissive materials can be polymeric substances, for example, polyphenylenevinylene derivatives, dialkoxy-polyphenylenevinylenes, poly-para-phenylene derivatives, and polyfluorene derivatives, as taught by Wolk and others in commonly assigned US-A-6,194,119 B1 and references therein.

Electron-Transport (ET) Material

[0053] Preferred electron transport materials for use in organic EL devices of this invention are metal chelated oxinoid compounds, including chelates of oxine itself (also commonly referred to as 8-quinolinol or 8-hydroxyquinoline). Such compounds help to inject and transport electrons and exhibit both high levels of performance and are readily fabricated in the form of thin films. Exemplary of contemplated oxinoid compounds are those satisfying structural Formula (E), previously described.

[0054] Other electron-transporting materials include various butadiene derivatives as disclosed in US-A-4,356,429 and various heterocyclic optical brighteners as described in US-A-4,539,507. Benzazoles satisfying structural Formula (G) are also useful electron transporting materials.

[0055] Other electron-transport materials can be polymeric substances, for example, polyphenylenevinylene derivatives, poly-para-phenylene derivatives, polyfluorene derivatives, polythiophenes, polyacetylenes, and other conductive polymeric organic materials such as those listed in commonly assigned US-A-6,221,553 B1 and references therein.

[0056] In some instances, a single layer can serve the function of supporting both light emission and electron transport, and will therefore include emissive material and electron transport material.

Anode Material

[0057] The conductive anode layer is formed over the substrate and, when EL emission is viewed through the anode, should be transparent or substantially transparent to the emission of interest. Common transparent anode materials used in this invention are indium-tin oxide and tin oxide, but other metal oxides can work including, but not limited to, aluminum- or indium-doped zinc oxide, magnesium-indium oxide, and nickel-tungsten oxide. In addition to these oxides, metal nitrides, such as gallium nitride, and metal selenides, such as zinc selenide, and metal sulfides, such as zinc

sulfide, can be used as an anode material. For applications where EL emission is viewed through the top electrode, the transmissive characteristics of the anode material are immaterial and any conductive material can be used, transparent, opaque or reflective. Example conductors for this application include, but are not limited to, gold, iridium, molybdenum, palladium, and platinum. Typical anode materials, transmissive or otherwise, have a work function of 4.1 eV or greater. Desired anode materials can be deposited by any suitable means such as evaporation, sputtering, chemical vapor deposition, or electrochemical means. Anode materials can be patterned using well-known photolithographic processes.

Cathode Material

[0058] When light emission is through the anode, the cathode material can be comprised of nearly any conductive material. Desirable materials have good film-forming properties to ensure good contact with the underlying organic layer, promote electron injection at low voltage, and have good stability. Useful cathode materials often contain a low work function metal (< 4.0 eV) or metal alloy. One preferred cathode material is comprised of a Mg:Ag alloy wherein the percentage of silver is in the range of 1 to 20 %, as described in US-A-4,885,221. Another suitable class of cathode materials includes bilayers comprised of a thin layer of a low work function metal or metal salt capped with a thicker layer of conductive metal. One such cathode is comprised of a thin layer of LiF followed by a thicker layer of Al as described in US-A-5,677,572. Other useful cathode materials include, but are not limited to, those disclosed in US-A-5,059,861; US-A-5,059,862; and US-A-6,140,763.

[0059] When light emission is viewed through the cathode, the cathode must be transparent or nearly transparent. For such applications, metals must be thin or one must use transparent conductive oxides, or a combination of these materials. Optically transparent cathodes have been described in more detail in US-A-5,776,623. Cathode materials can be deposited by evaporation, sputtering, or chemical vapor deposition. When needed, patterning can be achieved through many well known methods including, but not limited to, through-mask deposition, integral shadow masking as described in US-A-5,276,380 and EP 0 732 868, laser ablation, and selective chemical vapor deposition.

[0060] FIG. 5 shows a block diagram of one embodiment of the electrooptical subsystems that are used to process signals and detect the positions of the fiducial marks. These subsystems include host PC **102**, image processor **104**, and motion control electronics **106**. These can be separate units, or image processor **104** or motion control electronics **106** or both can be incorporated into host PC **102**. Host PC **102** communicates with image processor **104**, and allows the host PC to measure the light level incident on light detectors **22** and **23**. Image processor **104** amplifies signal **108** provided by light detector **22** and amplifies signal **110** provided by light detector **23**. Image processor **104** provides such amplified signals to host PC **102**. Host PC **102** can use such amplified signals to compute information from the detection of fiducial marks such as **40** to determine the position and orientation of substrate **10**. Host PC **102** is also connected to motion control electronics **106**, which controls the motion and position of the translation and rotation stages that comprise apparatus **18**. This provides the relative motion between the laser **100** and the substrate **10**, which thereby provides for laser spot scans **48** on substrate **10**. By providing for such relative motion, laser beam **74** can be scanned over a portion of substrate **10** that includes fiducial mark **40** and light detector **22**. Relative motion can then be provided in a direction perpendicular to laser spot scan **48** and the process repeated. During this time, the output from light detector **22** can be monitored and correlated with position information from motion control electronics **106**. In such a manner, image processor **104** can build a raster image of the position of fiducial mark **40**. By a similar process, a raster image of the position of fiducial mark **42** can be obtained at light detector **23**.

[0061] FIG. 6 is a block diagram showing the overall steps in detecting the positions of the fiducial marks using two such marks and in aligning a substrate for use in manufacture of OLED displays. The process begins with placing a substrate with fiducial marks on the translation/rotation stage (Step **122**). Relative motion is provided such that the laser is scanned in a first direction over the region of the light detector where the fiducial mark is approximately located (Step **124**). The incident intensity is measured by image processor **104** and host PC **102** to yield an intensity versus position along the scan, as shown in FIG. 2 (detecting Step **130**). Host PC **102** determines if the scan is the last scan over the light detector (Step **132**). If the last scan has not been reached, the translation stage is advanced perpendicular to the scan direction (Step **134**) and the process is repeated. If the scanning of the light detector is complete (Step **132**), then the host PC determines if there are more fiducial marks to be scanned (Step **138**). If there are more fiducials, relative motion is provided to move the laser beam to the start of the next fiducial mark (Step **140**) and the scanning is repeated (Step **124** and following). If the last fiducial has been scanned, host PC **102** determines the absolute translational and angular position of the fiducial marks.

[0062] For example, the position and orientation of substrate **10** can be determined based on information computed from the detection of fiducial marks such as **40** and **42**. If there is any misalignment, then using the known locations of the fiducial marks the rotation and translation stages are adjusted, the image file is adjusted, the start of image is adjusted or some combination of these actions is done to allow the image to be laser transferred at precise locations (Step **142**). Such actions can include mechanical or digital translation, mechanical or digital rotation, and mechanical or digital stretching of the image to be transferred. Such methods are well-known in the art. The transfer is conducted by placing

a donor sheet in a transfer relationship relative to the substrate **10** and providing relative movement between laser beam **74** and substrate **10**, and activating laser beam **74** in accordance with the determined position and orientation of substrate **10** to cause the transfer of organic material **72** from donor element **16** onto substrate **10** at the desired positions, for example, pixel portions **12**. Laser beam **74** can be activated according to timing or according to position (Step **144**). A method for transferring material from the donor to the substrate. The process is then ended (Step **148**).

[0063] Other features of the invention are included below.

[0064] The method wherein the fiducial mark has a specified shape.

[0065] The method wherein the specified shape is a cross.

[0066] The method wherein when the laser beam impinges upon the fiducial mark in multiple locations, information is recorded and such recorded information is used to calculate the orientation of the substrate.

[0067] The method wherein the two fiducial marks are positioned outside the area where the organic material is to be transferred onto the substrate to form one or more OLED displays.

[0068] The method wherein the detecting step includes providing a light detector either above or below the substrate and amplifying the signal provided by the light detector and using such amplified signals to compute information from the detection of such fiducial marks to determine the position and orientation of the substrate.

[0069] A method of aligning a substrate and making OLED displays with a laser which produces a beam that causes the transfer of organic material from a donor element to the substrate, comprising the steps of:

a) providing at least one fiducial mark on the substrate;

b) positioning the substrate relative to the laser and providing relative movement between the substrate and the laser and the laser beam until the laser beam impinges upon the fiducial mark;

c) detecting when the laser beam impinges upon the fiducial mark and determining the position and orientation of the substrate;

d) positioning the donor element between the laser and the substrate; and

e) providing relative movement between the laser beam and the substrate and activating the laser beam in accordance with the determined position and orientation to cause the transfer of organic material onto the substrate.

[0070] The method wherein the fiducial mark has a specified shape.

[0071] The method wherein the specified shape is a cross.

[0072] The method wherein when the laser beam impinges upon the fiducial mark in multiple locations, information is recorded and such recorded information is used to calculate the orientation of the substrate.

[0073] The method wherein the donor element permits sufficient light to pass therethrough to impinge upon the fiducial mark.

[0074] The method wherein the detecting step includes providing a light detector either above or below the substrate and amplifying the signal provided by the light detector and using such amplified signals to compute information from the detection of such fiducial marks to determine the position and orientation of the substrate.

Claims

1. A method of manufacturing an OLED display with a laser (100) which produces a beam (74) that causes a transfer of organic material (72) from a donor element (16) to a substrate (10), the method comprising the steps for aligning the substrate (10) of:

a) providing at least one fiducial mark (40, 42) on the substrate (10);

b) positioning the substrate (10) relative to the laser (100) and providing relative movement between the substrate (10) and the laser (100) and the laser beam (74) until the laser beam (74) impinges upon the fiducial mark (40, 42);

c) detecting when the laser beam (74) impinges upon the fiducial mark (40, 42) and determining the position and orientation of the substrate (10); and

d) providing relative movement between the laser beam (74) and the substrate (10) and activating the laser beam (74) in accordance with the determined position and orientation of the substrate (10) to cause the transfer of organic material (72) from the donor element (16) onto the substrate (10).

2. The method of claim 1, wherein the fiducial mark (40, 42) has a specified shape.

3. The method of claim 2 wherein the specified shape is a cross.

4. The method of claim 2, wherein when the laser beam (74) impinges upon the fiducial mark (40, 42) in multiple

locations, information is recorded and using such recorded information to calculate the orientation of the substrate (10).

5. The method of claim 1 further including providing a laser (100) which produces the laser beam used in steps b) and d).

Patentansprüche

1. Verfahren zum Herstellen einer OLED Anzeige mit einem Laser (100), welcher einen Strahl (74) erzeugt, der einen Transfer von organischem Material (72) von einem Donatorelement (16) auf ein Substrat (10) herbeiführt, wobei das Verfahren die Schritte für eine Justierung des Substrats (10) umfasst:

- a) Bereitstellen von wenigstens einer Messmarke (40, 42) auf dem Substrat (10);
- b) Positionieren des Substrats (10) relativ zu dem Laser (100) und Bereitstellen relativer Bewegung zwischen dem Substrat (10) und dem Laser (100) und dem Laserstrahl (74) bis der Laserstrahl (74) auf die Messmarke (40, 42) trifft;
- c) Detektieren, wenn der Laserstrahl (74) auf die Messmarke (40, 42) trifft und Ermitteln der Position und Orientierung des Substrats (10); und
- d) Bereitstellen einer relativen Bewegung zwischen dem Laserstrahl (74) und dem Substrat (10) und Aktivieren des Laserstrahls (74) in Übereinstimmung mit der ermittelten Position und Orientierung des Substrats (10), um den Transfer von organischem Material (72) von dem Donatorelement (16) auf das Substrat (10) herbeizuführen.

2. Verfahren nach Anspruch 1, bei dem die Messmarke (40, 42) eine vorgegebene Form aufweist.

3. Verfahren nach Anspruch 2, bei dem die vorgegebene Form ein Kreuz ist.

4. Verfahren nach Anspruch 2, bei dem, wenn der Laserstrahl (74) auf die Messmarke (40, 42) an mehreren Stellen trifft, Information aufgezeichnet wird und diese aufgezeichnete Information genutzt wird, um die Orientierung des Substrats (10) zu berechnen.

5. Verfahren nach Anspruch 1, welches ferner enthält Bereitstellen eines Lasers (100), welcher einen Laserstrahl erzeugt, der in den Schritten b) und d) genutzt wird.

Revendications

1. Procédé de fabrication d'un afficheur à OLED avec un laser (100) qui produit un faisceau (74) qui cause un transfert de matière organique (72) d'un élément donneur (16) à un substrat (10), le procédé comprenant les étapes pour aligner le substrat (10) de :

- a) prévision d'au moins un repère de centrage (40, 42) sur le substrat (10) ;
- b) positionnement du substrat (10) par rapport au laser (100) et prévision d'un mouvement relatif entre le substrat (10) et le laser (100) et le faisceau laser (74) jusqu'à ce que le faisceau laser (74) vienne frapper le repère de centrage (40, 42) ;
- c) détection de quand le faisceau laser (74) vient frapper le repère de centrage (40, 42) et détermination de la position et de l'orientation du substrat (10) ; et
- d) prévision d'un mouvement relatif entre le faisceau laser (74) et le substrat (10) et activation du faisceau laser (74) en fonction de la position et de l'orientation déterminées du substrat (10) pour causer le transfert de matière organique (72) de l'élément donneur (16) au substrat (10).

2. Procédé selon la revendication 1, dans lequel le repère de centrage (40, 42) a une forme spécifiée.

3. Procédé selon la revendication 2, dans lequel la forme spécifiée est une croix.

4. Procédé selon la revendication 2, dans lequel, lorsque le faisceau laser (74) vient frapper le repère de centrage (40, 42) en des emplacements multiples, une information est enregistrée et utilisation d'une telle information enregistrée pour calculer l'orientation du substrat (10).

5. Procédé selon la revendication 1, incluant en outre la prévision d'un laser (100) qui produit le faisceau laser utilisé aux étapes b) et d).

5

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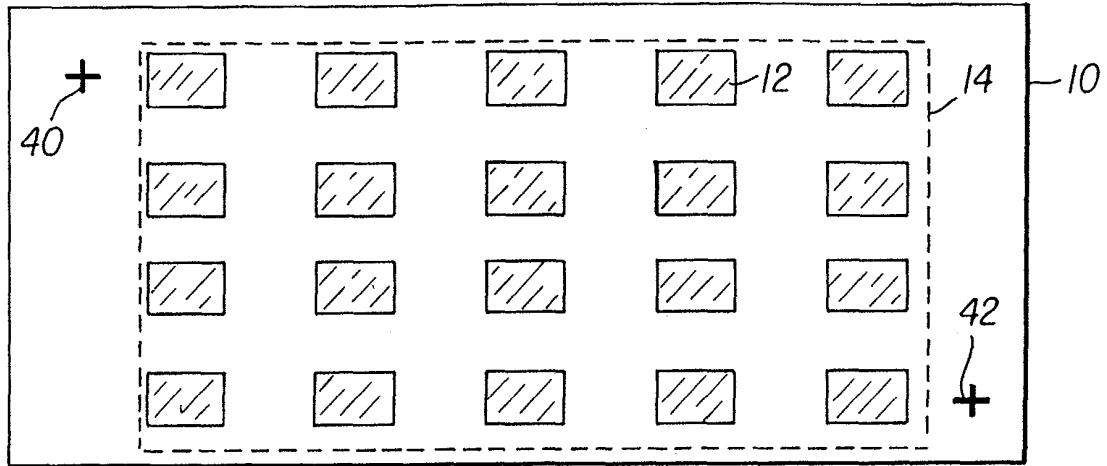


FIG. 1a

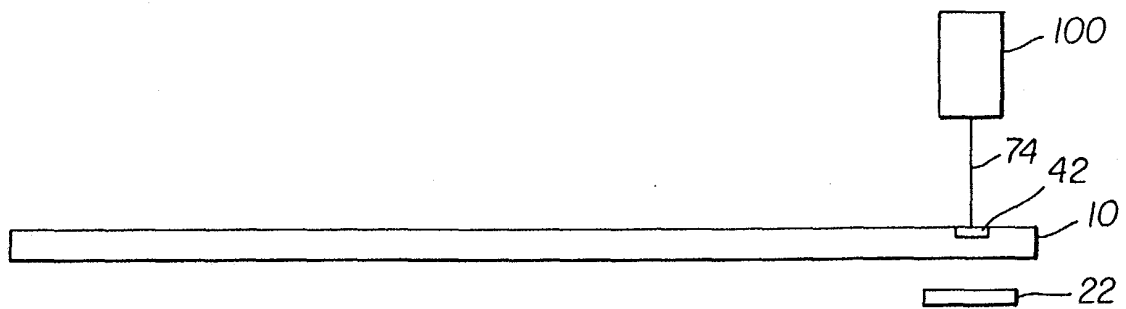


FIG. 1b

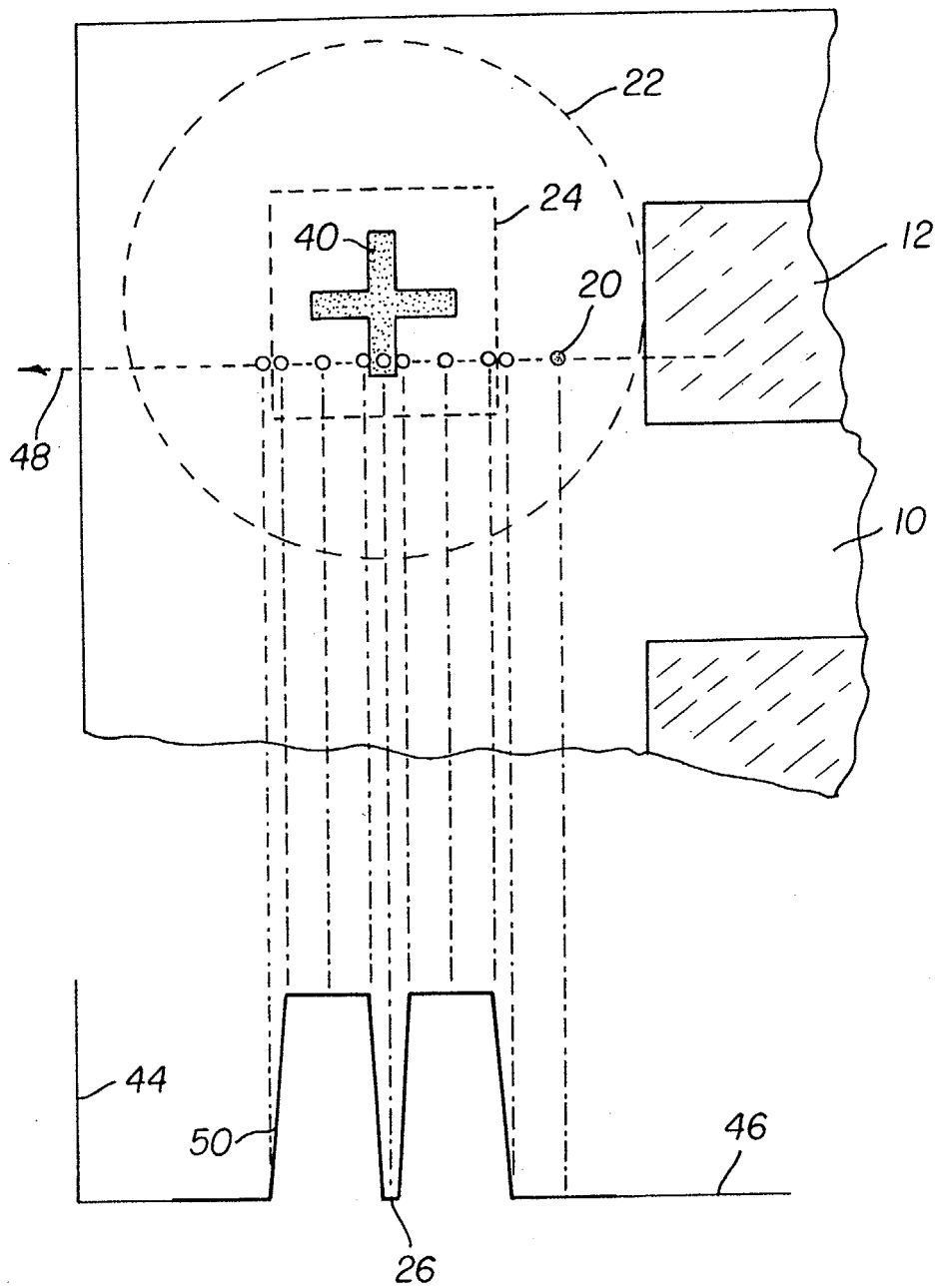


FIG. 2

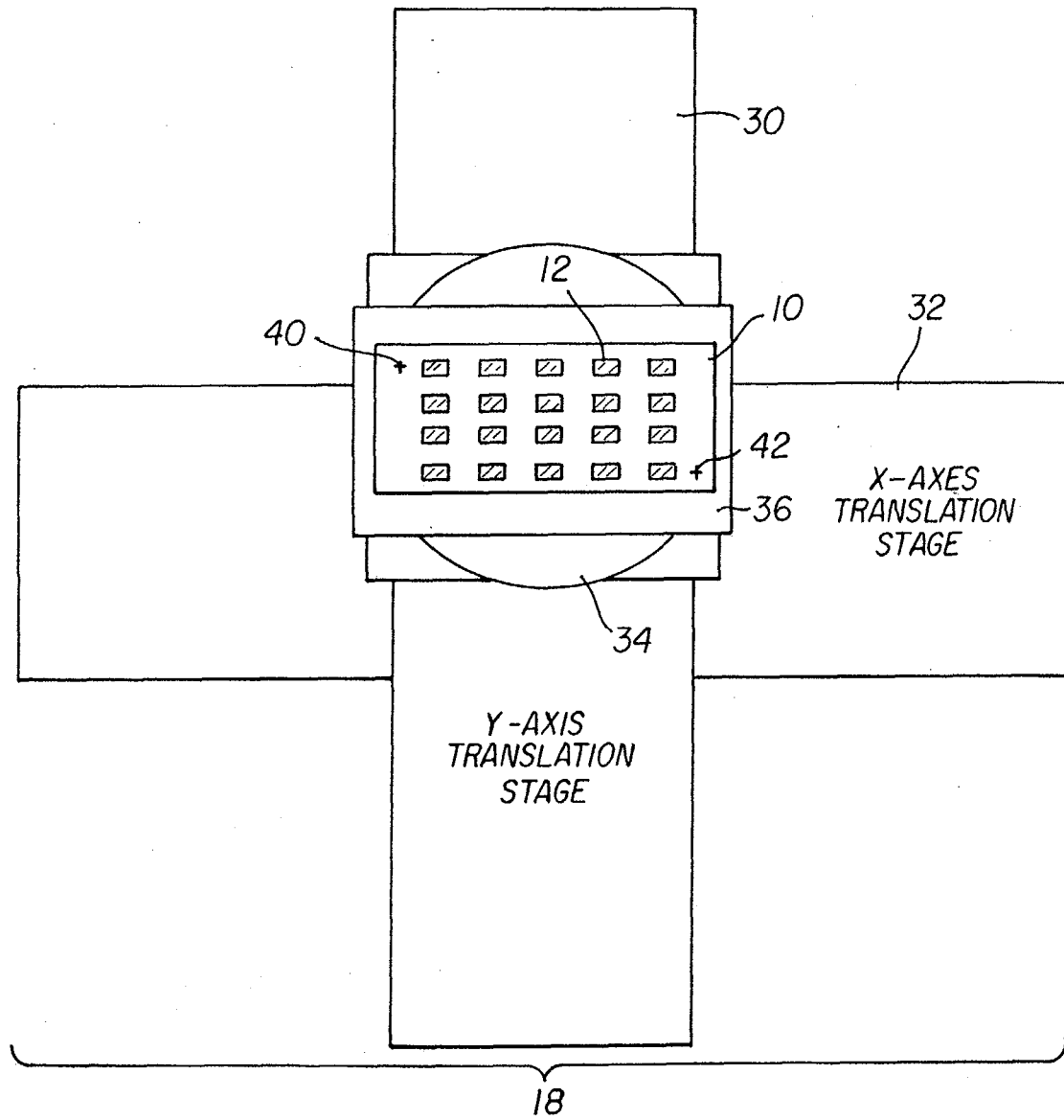


FIG. 3

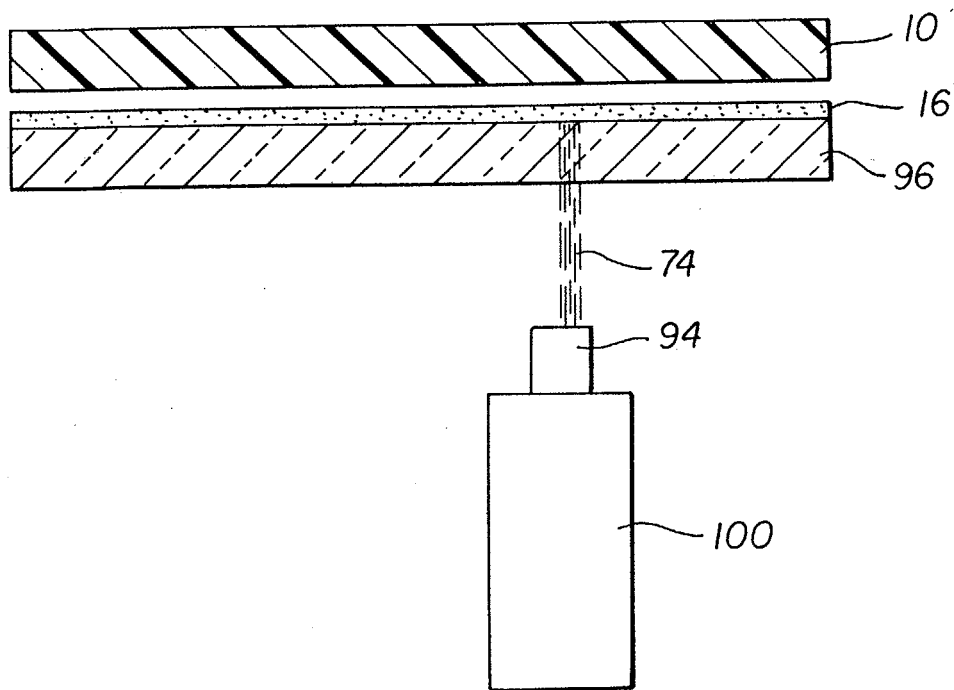


FIG. 4a

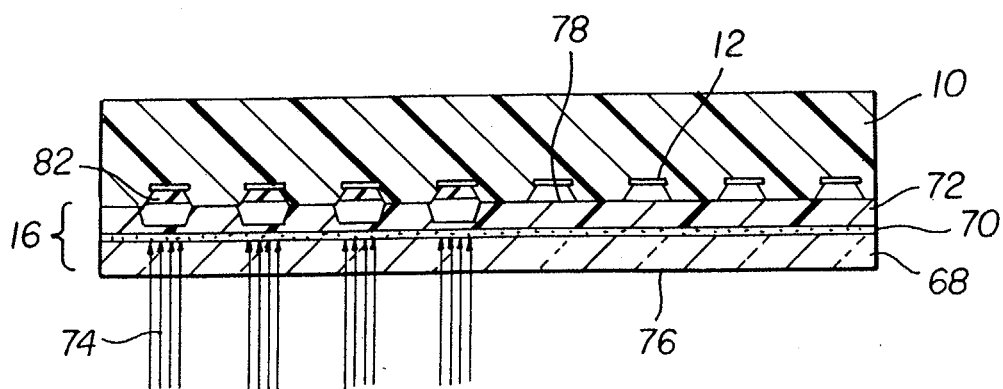


FIG. 4b

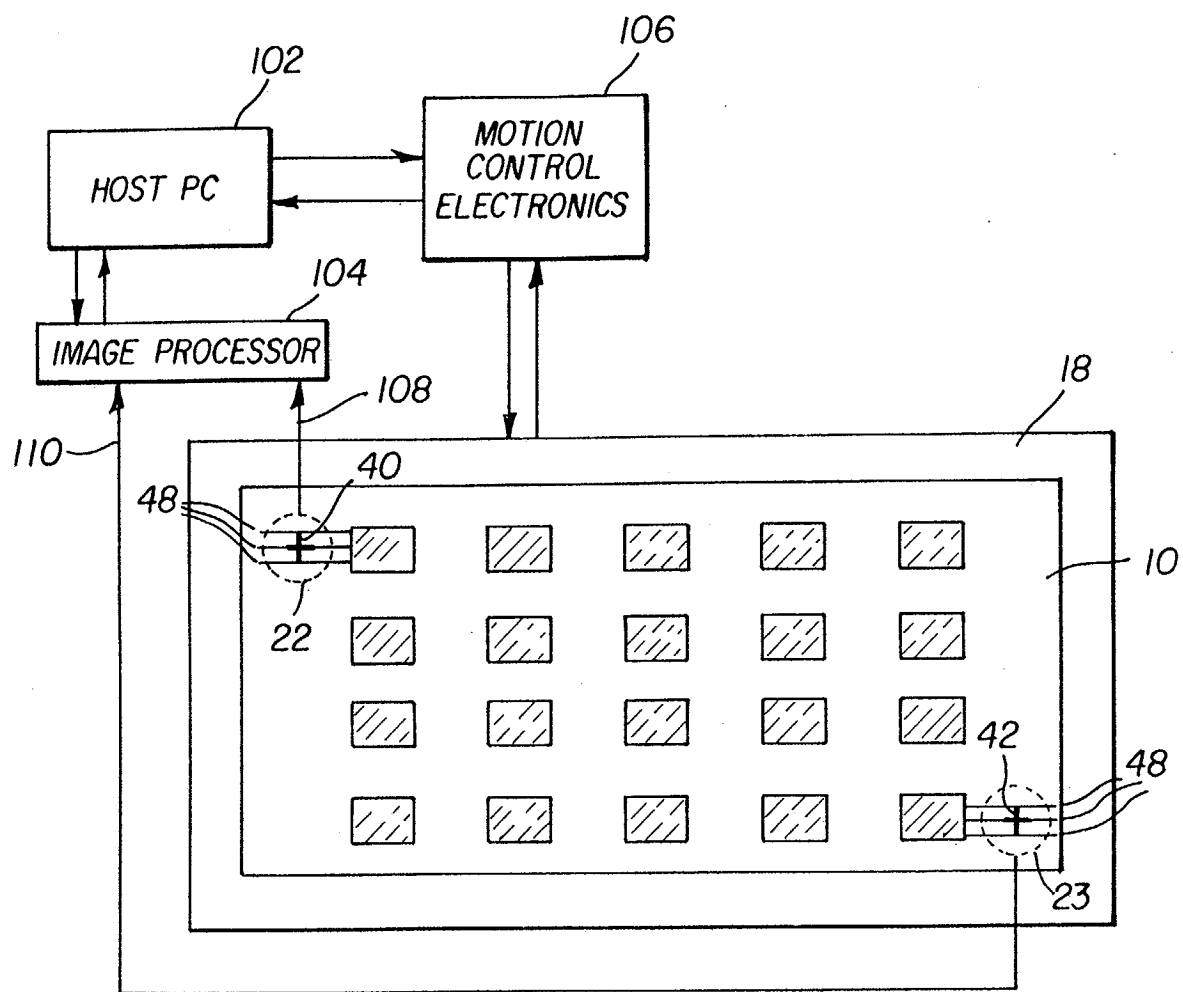


FIG. 5

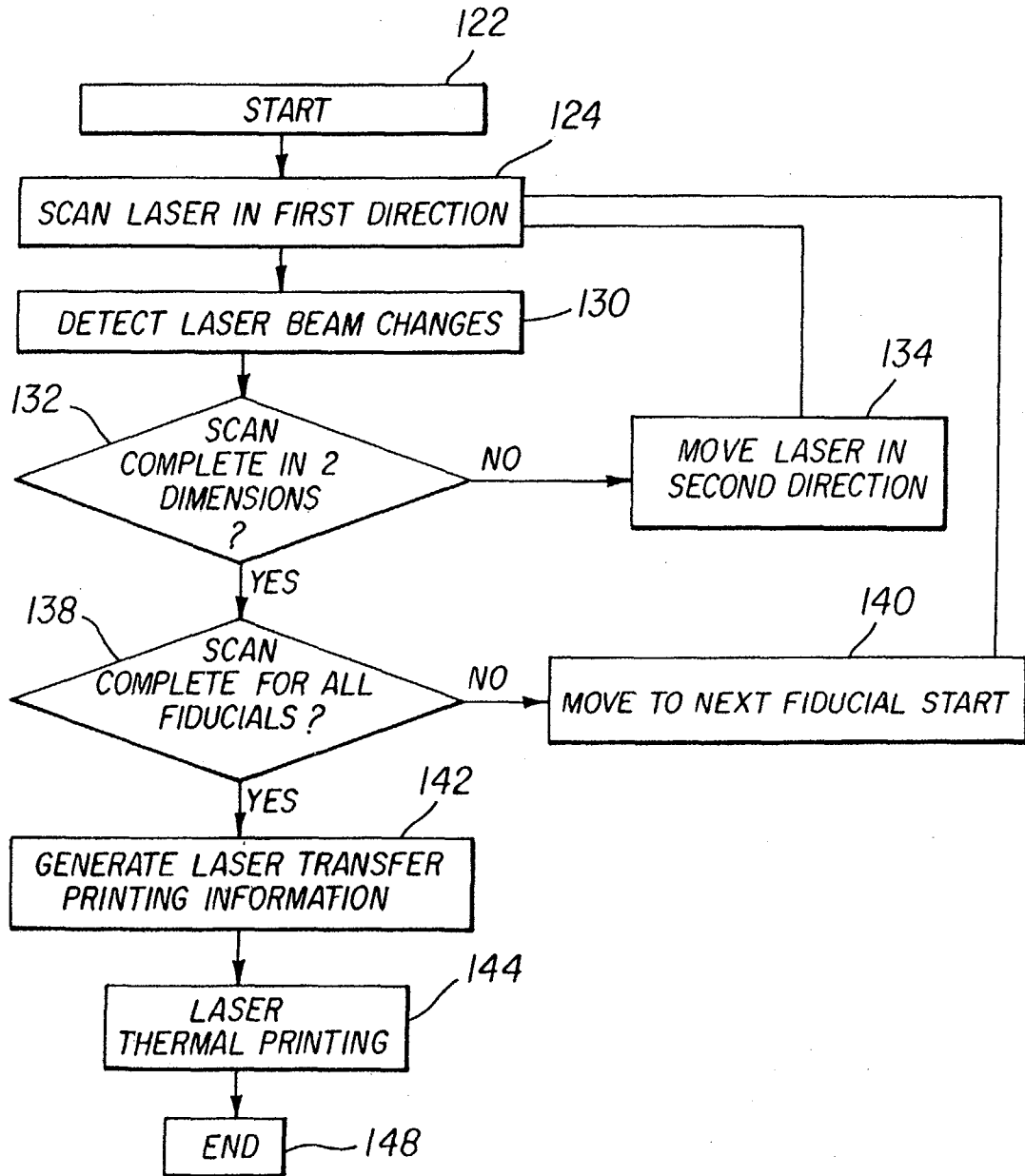


FIG. 6

REFERENCES CITED IN THE DESCRIPTION

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专利名称(译)	通过在基板上使用基准标记来制造OLED显示器的方法，用于将有机材料从施主激光转移到基板		
公开(公告)号	EP1394872B1	公开(公告)日	2015-09-23
申请号	EP2003077590	申请日	2003-08-18
[标]申请(专利权)人(译)	伊斯曼柯达公司		
申请(专利权)人(译)	伊士曼柯达公司		
当前申请(专利权)人(译)	全球OLED科技有限责任公司		
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发明人	BEDZYK, MARK D. TUTT, LEE W.		
IPC分类号	H01L51/56 B41M5/26 H05B33/10 G09F9/00 H01L51/00 H01L51/30 H01L51/40 H01L51/50 H05B33/02		
CPC分类号	B41M5/265 C23C14/048 H01L51/0013 H01L51/005 H01L51/0052 H01L51/0059 H01L51/0062 H01L51/0077 H01L51/0081 H01L51/0084 H01L51/0085 H01L51/0089 H01L51/56		
优先权	10/230934 2002-08-29 US		
其他公开文献	EP1394872A2 EP1394872A3		
外部链接	Espacenet		

摘要(译)

一种将用于制造OLED显示器的基板与激光器对准的方法，该激光器产生使有机材料从供体元件转移到基板的光束，包括在基板上提供至少一个基准标记;将基板相对于激光器定位并提供基板与激光器和激光束之间的相对运动，直到激光束照射在基准标记上;检测激光束何时撞击基准标记并确定基板的位置和方向。

